Charge Transfer Ine ciency Studies for CCD Vertex Detectors at a LC

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A bstract

The Linear Collider F lavour Identi cation (LCFI) collaboration studies CCD detectors for quark avour identi cation in the fram ework of a future linear e⁺ e collider. The avour identi cation is based on precision reconstruction of charged tracks very close to the interaction point. Therefore, this detector will be exposed to a high level of radiation and thus an important aspect of the vertex detector developm ent are radiation hardness studies. Results of detailed simulations of the charged transport properties of a CCD prototype chip are reported and com pared with initial measurements. The simulation program allows to study the e ect of radiation dam age after the exposure of the detector to a realistic radiation dose, which is expected in the environment of detector operation at a future LC.

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1. INTRODUCTION

An important requirem ent of a vertex detector is to remain tolerant to radiation damage for its anticipated lifetime. Two dierent CCDs have been considered in this study. The majority of simulations so far have been performed for the 3-phase CCD, CCD 58, with serial readout. First data measurements have been performed on an unirradiated 2-phase column parallel CCD, CPC-1.

CCDs su er from both surface and bulk radiation dam age, however, when considering charge transfer losses in buried channel devices only bulk traps are important. These defects create energy levels between the conduction and valance band, hence electrons m ay be captured by these new levels. Captured carriers are also em itted back to the conduction band, but on a di erent time scale. For a signal packet this m ay lead to a decrease in charge as it is transfered to the output and m ay be quanti ed by its Charge Transfer Ine ciency (CTI), where a charge of am plitude Q_0 transported across m pixels will have a reduced charge given by

$$Q_m = Q_0 (1 \quad CT I)^m$$
: (1)

The CTI value depends on m any parameters, some related to the trap characteristics such as: trap energy level, capture cross-section, and trap concentration. Operating conditions also a lect the CTI as there is a strong tem perature dependence on the trap capture rate and also a variation of the CTI with the readout frequency. O ther factors are also relevant, for example the occupancy ratio of pixels, which in uences the fraction of led traps in the CCD transport region. D ark current e lects have been m easured.

2. SIMULATION

The simulations with ISE-TCAD (version 7.5) are performed using a 2-dimensional model for a 3-phase CCD (Fig. 1). Parameters of interest are the readout frequency, up to 50 MHz, and the operating temperature between 100 K and 250 K. The charge in transfer and the trapped charge is shown in Fig. 2. From the two traps considered only the 0.17 eV trap produced a non-negligible CTI for the explored parameter ranges. The signal charge used in the simulation represents a charge deposited from an Fe^{55} source. The X-ray emission (mainly 5.9 keV) generates about 1620 electrons in the CCD, which is similar to the charge generated by a MIP. The linearity of the CTI value with respect to the trap concentration was veried in the simulation.



Figure 2: Left: Signal charge density, alm ost at output gate. Right: Trapped charge density, from transfer of signal charge.

2.1. 0.44 eV Trap CTI Contribution

Empty trap simulation may not be a good approximation. We consider partially led traps to improve the simulation by representing a continuous readout process. The results from the initially empty and partially led traps are compared in Fig. 3. A negligible contribution to the CTI from 0.44 eV trapping for partially led traps (due to long emission time) are obtained. Thus, the 0.44 eV traps are ignored in further studies.



Figure 3: Left: CTI value for initially empty 0.44 eV traps. Right: Partially lled 0.44 eV traps.

2.2. 0.17 eV Trap CTI Contribution

Figure 4 shows the CTI simulation for initially empty and partially led traps. A clear peak structure is observed. New experimental data will cover the simulated temperature range.



Figure 4: Left: CTI value for initially empty 0.17 eV traps, 0.44 eV traps and their sum . Right: Partially led 0.17 eV traps.

2.3. Frequency Dependence

The frequency dependence is shown in Fig. 5 for initially empty and partially led traps. For higher readout frequency there is less time to trap the charge, and thus the CTI is reduced near the CTI peak region. At high tem peratures, the em ission time is so short that trapped charges rejoin the passing signal.



Figure 5: Left: Frequency dependence for initially empty 0.17 eV traps. Right: Partially lled 0.17 eV traps.

3. SIMPLE MODEL

A simple model of charge trapping was constructed that considered the capture and emission of electrons from traps to and from the conduction band. These processes are parameterized by two timescales to form a dimensial rate equation. Solution of this equation with relevant boundary conditions allowed this simple model to be compared with the full ISE simulation results.



Figure 6: Left: Traps capture electrons from the signal charge and electrons are emitted from the led traps. Right: Com parison between simple model (solid lines) and ISE simulation (dots) for three readout frequencies.

Figure 6 shows the comparison between the full simulation and the simple model as a function of the temperature. At low temperatures the time for traps to emit captured electrons is far longer than the readout time, hence traps remain led and no further electrons can be captured. At high temperatures the emission time is much faster than the readout frequency, so captured electrons are released back to the conduction band fast enough to rejoin their original signal packet. The CTI value is again reduced. Slower readout frequencies have higher CTI values near their peaks as each pixel has a longer occupation time for the signal charge resulting in greater net electron capture.

4. INITIAL DATA MEASUREMENTS

For the environm ent of a future Linear C ollider a serial readout for CCD s is no longer an option. Instead column parallel technology, using readout electronics for each column, are indevelopment to cope with the required readout rate. CPC-1 is a prototype 2-phase CCD capable of 25 MHz readout frequency. Initial measurements have been performed on an unirradiated device in standalone mode, where four columns of the CCD were connected to external ADC ampliers. An Fe^{55} source provides the signal charge (Fig. 7). The determination of the CTI involves measuring the charge reduction as a function of the pixel number from a known initial charge. The results so far have shown small CTI values (< 10⁵) for the unirradiated CCD under normal operation conditions. It is possible to induce CTI-like elects by reducing the clock voltages used to transfer charge. For 1 MHz readout the CTI value was observed to increase sharply below 1.9 V (peak-to-peak).

4.1. CTI - Event Selection

The signal is induced by an Fe⁵⁵ source which provides isolated hits of about 1620 electrons in order to determ ine the CTI value. Hits are located using a 3x3 cluster method and selection criteria are applied: Pixel amplitude > 5 noise, $\frac{8}{i=1}$ jcluster_ij< 8 noise. Events are selected within 2 of the signal peak as shown in Fig. 8.

4.2. CTI - Determination

The CTI is determ ined from isolated pixel hits. The distribution of the ADC amplitude Q against the pixel number gives CTI = $\frac{1}{Q_0} \frac{dQ}{d(P \text{ ixel})}$; where Q_0 is the intercept from a straight-line t. An example for an unimadiated device and low clock voltage is given in Fig. 9. The decrease of the clock voltage reduces the transfer e ciency which provides a possibility to measure CTI values as function of the clock voltage.



Figure 9: Left: CTI determ ination. Right: CTI as function of clock voltage.

4.3. Dark Current

Some them ally generated electrons are captured in the potential wells. The collected charge is proportional to the integration time. 10 overclocks sampled per frame are used as reference level. The gain (e /ADC) is calibrated from an Fe⁵⁵ source (at each temperature). From a t to $J_{lc} = T^3 \exp($ =T), a uniform dark current characteristics is observed across the four channels (Fig. 10).





Figure 10: Upper left: Dark current m easurement m ethod.Upper right: Dark current at dierent tem peratures.Lower left: Dark current t to theory expectation.

5. SUMMARY and OUTLOOK

In sum mary, radiation hardness e ects have been sinulated for a serial readout CCD, CCD 58. A simple model has been developed and compares well with the simulation which shows the strong dependence on the operating conditions of the CCD. Measurements performed on a prototype column parallelCCD (CPC-1) display as expected no measurable CTI for the unirradiated system. CTI-like e ects were induced by reducing the clock voltage to explore the CTIm easurement method. Comparisons with experimental data from irradiated CCDs will be carried out at a test-stand. First, the expected peak structure will be investigated with experimental data. The test-stand at LiverpoolUniversity has been shown to operate in the require temperature range. The CCD prototype performance will be compared with simulations. Initial experience with this prototype has already been gained at the Rutherford Appleton Laboratory (RAL). The veri cation of the simulation results and the tuning of the simulation is important for the studies to guide the future CCD development as vertex detector for a future Linear Collider.

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